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•	Wide-Word	Organization	256K	×	16
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- Single 5-V Power Supply
- All inputs/Outputs Fully TTL Compatible
- Static Operations (No Clocks, No Refresh)
- Max Access/Min Cycle Time

V_{CC} ± 10% '27C/PC240-10 100 ns '27C/PC240-12 120 ns '27C/PC240-15 150 ns

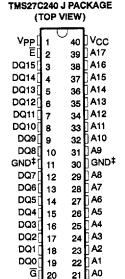
- 16-Bit Output For Use in Microprocessor-Based Systems
- Very High Speed SNAP! Pulse Programming
- Power-Saving CMOS Technology
- 3-State Output Buffers
- 400-mV Minimum DC Noise Immunity With Standard TTL Loads
- Latchup Immunity of 250 mA on All input and Output Lines
- No Pullup Resistors Required
- Low Power Dissipation (V_{CC} = 5.5 V)
 - Active ... 275 mW Worst Case
 - Standby . . . 0.55 mW Worst Case (CMOS-Input Levels)
- PEP4 Version Available With 168-Hour Burn-In, and Choices of Operating Temperature Ranges

description

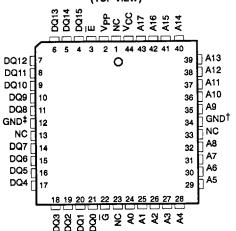
The TMS27C240 series are 4194304-bit, ultraviolet-light erasable, electrically programmable read-only memories.

The TMS27PC240 series are 4194304-bit, one-time electrically programmable read-only memories.

These devices are fabricated using power-saving CMOS technology for high speed and simple interface with MOS and bipolar circuits. All inputs (including program data inputs) can be driven by Series 74 TTL circuits without the use of external pull-up resistors. Each output can drive one Series 74 TTL circuit without external resistors.



TMS27PC240 FN PACKAGE (TOP VIEW)



PIN	PIN NOMENCLATURE					
A0-A17	Address Inputs					
DQ0-DQ15	Inputs (programming) / Outputs					
Ē	Chip Enable					
G	Output Enable					
GND	Ground					
NC	No Connection					
V _{CC}	5-V Supply					
VPP	13-V Power Supply ‡					

[†] Pins 11 and 30 (J package) and pins 12 and 34 (FN package) must be connected externally to ground.

PRODUCTION DATA information is current as of publication det Products conform to specifications per the terms of Texas instrument standard werranty. Production processing does not necessarily includtesting of all parameters.



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[‡] Only in program mode

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description (continued)

The TMS27C240 EPROM is offered in a dual-in-line ceramic package (J suffix) designed for insertion in mounting hole rows on 15,2-mm (600-mil) centers. The TMS27C240 is also offered with two choices of temperature ranges of 0°C to 70°C (JL suffix) and – 40°C to 85°C (JE suffix). The TMS27C240 is also offered with 168-hour burn-in on both temperature ranges (JL4 and JE4 suffixes). (See table below.)

The TMS27PC240 OTP PROM is offered in a 44-lead plastic leaded chip carrier package using 1,25-mm (50-mil) lead spacing (FN suffix). The TMS27PC240 is characterized for a temperature range of 0°C to 70°C.

	TEMPERAT	R OPERATING URE RANGES EP4 BURN-IN	SUFFIX FOR PEP4 168 HR. BURN-IN VS TEMPERATURE RANG			
	0°C TO 70°C	- 40°C TO 85°C	0°C TO 70°C	- 40°C TO 85°C		
TMS27C240-XXX	JL	JE	JL4	JE4		
TMS27PC240-XXX	FNL	FNE	N/A	N/A		

These EPROMs and OTP PROMs operate from a single 5-V supply (in the read mode), and they are ideal for use in microprocessor-based systems. One other (13 V) supply is needed for programming . All programming signals are TTL level. For programming outside the system, existing EPROM programmers can be used.

operation

The eight modes of operation for the TMS27C240 and TMS27PC240 are listed in the following table. The read mode requires a single 5-V supply. All inputs are TTL level except for V_{PP} during programming (13 V for SNAP! Pulse), and 12 V on A9 for the signature mode.

		FUNCTION †									
	Ē	G	Vpp	Vcc	A9	A0	1/0				
Read	V _{IL}	V _{IL}	Vcc	Vcc	×	х	DQ0-DQ7 DQ8-DQ15				
Output Disable	VIL	ViH	Vcc	Vcc	×	X	Hi-Z				
Standby	ViH	×	Vcc	Vcc	×	Х	Hi-Z				
Programming	VIL	VIH	Vpp	Vcc	×	Х	Data In				
Verify	VIH	V _{IL}	V _{PP}	Vcc	X	X	Data Out				
Program Inhibit	v_{IH}	V _{IH}	VPP	Vcc	х	х	Hi-Z				
Signature Mode (Mfg)	VIL	V _{IL}	Vcc	Vcc	V _H ‡	V _{IL}	Mfg Code 0097				
Signature Mode (Device)	V _{IL}	VIL	Vcc	Vcc	∨ _H ‡	VIH	Device Code 0030				

TX can be VII or VIH.

read/output disable

When the outputs of two or more TMS27C240s or TMS27PC240s are connected in parallel on the same bus, the output of any particular device in the circuit can be read with no interference from the competing outputs of the other devices. To read the output of a single device, a low-level signal is applied to the \overline{E} and \overline{G} pins. All other devices in the circuit should have their outputs disabled by applying a high-level signal to one of these pins.



 $^{^{\}ddagger}V_{H} = 12 V \pm 0.5 V.$

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latchup immunity

Latchup immunity on the TMS27C240 and TMS27PC240 is a minimum of 250 mA on all inputs and outputs. This feature provides latchup immunity beyond any potential transients at the P.C. board level when the devices are interfaced to industry-standard TTL or MOS logic devices. Input-output layout approach controls latchup without compromising performance or packing density.

power down

Active I_{CC} supply current can be reduced from 50 mA to 1 mA by applying a high TTL input on \overline{E} and to 100 μ A by applying a high CMOS input on \overline{E} . In this mode all outputs are in the high-impedance state.

erasure (TMS27C240)

Before programming, the TMS27C240 is erased by exposing the chip through the transparent lid to a high intensity ultraviolet light (wavelength 2537 Å). The recommended minimum exposure dose (UV intensity × exposure time) is 15-W·s/cm². A 12-mW/cm², filterless UV lamp erases the device in 21 minutes. The lamp should be located about 2.5 cm above the chip during erasure. After erasure, all bits are in the high state. It should be noted that normal ambient light contains the correct wavelength for erasure. Therefore, when using the TMS27C240, the window should be covered with an opaque label.

initializing (TMS27PC240)

The one-time programmable TMS27PC240 PROM is provided with all bits in the logic high state, then logic lows are programmed into the desired locations. Logic lows programmed into an OTP PROM cannot be erased.

SNAP! Pulse programming

The TMS27C240 and TMS27PC240 are programmed by using the SNAP! Pulse programming algorithm. The programming sequence is shown in the SNAP! Pulse programming flow chart, see Figure 1.

The initial setup is $V_{PP} = 13 \text{ V}$, $V_{CC} = 6.5 \text{ V}$, $\overline{E} = V_{IH}$, and $\overline{G} = V_{IH}$. Once the initial location is selected, the data is presented in parallel (eight bits) on pins DQ0 through DQ15. Once addresses and data are stable, the programming mode is achieved when \overline{E} is pulsed low (V_{IL}) with a pulse duration of $t_{W(PGM)}$. Every location is programmed only once before going to interactive mode.

In the interactive mode, the word is verified at $V_{PP}=13$ V, $V_{CC}=6.5$ V, $\overline{E}=V_{IH}$, and $\overline{G}=V_{IL}$. If the correct data is not read, the programming is performed by pulling \overline{E} low with a pulse duration of $t_{W(PGM)}$. This sequence of verification and programming is performed up to a maximum of 10 times. When the device is fully programmed, all bytes are verified with $V_{CC}=V_{PP}=5$ V \pm 10%.

program inhibit

Programming can be inhibited by maintaining a high level input on the $\overline{\mathsf{E}}$ and $\overline{\mathsf{G}}$ pins.

program verify

Programmed bits can be verified with $V_{PP} = 13 \text{ V}$ when $\overline{G} = V_{IL}$ and $\overline{E} = V_{IH}$.



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signature mode

The signature mode provides access to a binary code identifying the manufacturer and type. This mode is activated when A9 (pin 31 for the J package) is forced to 12 V. Two identifier bytes are accessed by toggling A0. DQ0–DQ7 contain the valid codes. All other addresses must be held low. The signature code for these devices is 9730. A0 low selects the manufacturer's code 97 (Hex), and A0 high selects the device code 30 (Hex), as shown by the signature mode table below.

IDENTIFIER†					PI	NS				
IDENTIFIEN	A0	DQ7	DQ6	DQ5	DQ4	DQ3	DQ2	DQ1	DQ0	HEX
MANUFACTURER CODE	٧ _{IL}	1	0	0	1	0	1	1	1	97
DEVICE CODE	V _{IH}	0	0	1	1	0	0	0	0	30

[†] E = G = VIL, A9 = VH, A1 - A8 = VIL, A10-A17 = VIL, VPP = VCC, PGM = VIH or VIL.

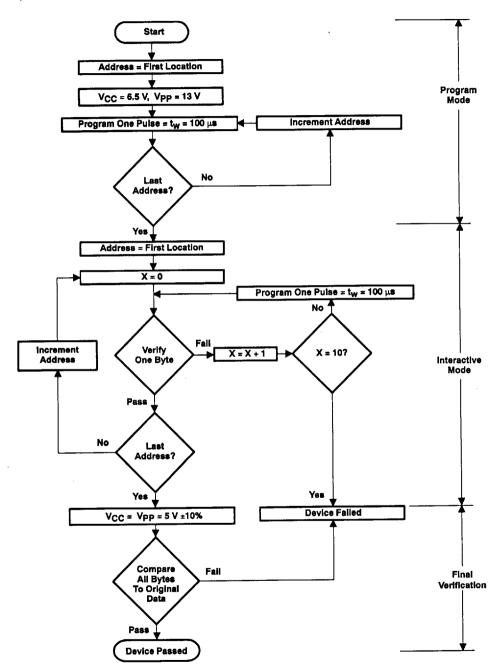
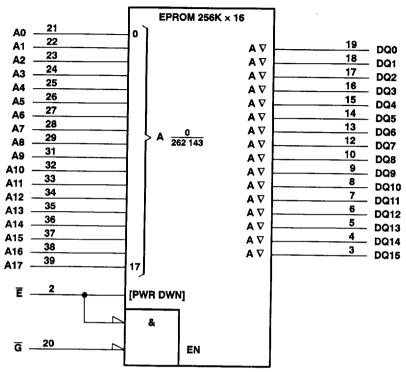


Figure 1. SNAP! Pulse Programming Flowchart



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logic symbol†



[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers are for the J package.

absolute maximum ratings over operating free-air temperature range (unles	s otherwise noted)‡
Supply voltage range, V _{CC} (see Note 1)	-0.6 V to 7 V
Supply voltage range, Vpp	
Input voltage range (see Note 1): All inputs except A9	$$ -0.6 V to V_{CC} + 1 V
A9	-0.6 V to 13.5 V
Output voltage range (see Note 1)	0.6 V to Vcc + 1 V
Operating free-air temperature range ('27C240JL and JL4,	
'27PC240FNL)	0° C to 70° C
Operating free-air temperature range ('27C240- JE and JE4)	- 40° C to 85° C
Storage temperature range, T _{sto}	-65°C to 150° C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to GND.



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recommended operating conditions

				MIN	NOM	MAX	UNIT
		Read mode (se	e Note 2)	4.5	5	5.5	V
VCC	Supply voltage	pply voltage SNAP! Pulse programming algorithm		6.25	6.5	6.75	
	Read mode		V _{CC} -0.6		V _{CC} +0.6	V	
VPP	Supply voltage	SNAP! Pulse p	rogramming algorithm	12.75	13	13.25	
			ΠL	2		V _{CC} +0.5	V
VIΗ	High-level dc input voltage		CMOS	V _{CC} - 0.2		V _{CC} +0.5	
			TTL	- 0.5		8.0	v
VIL	Low-level dc Input voltage		CMOS	- 0.5		0.2	•
TA	Operating free-air temperature		'27C240JL, JL4 '27PC240FNL	0		70	့
TA	Operating free-air temperature		'27C240JE, JE4	40		85	°C

NOTE 2: VCC must be applied before or at the same time as Vpp and removed after or at the same time as Vpp. The device must not be inserted into or removed from the board when Vpp or VcC is applied.

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature

	PARAMETER	TEST CONDITIONS	MIN MAX	UNIT
		Ι _{ΟΗ} = - 400 μΑ	2.4	v
۷он	High-level dc output voltage	I _{OH} = - 20 μA	V _{CC} = 0.1	,
		I _{OL} = 2.1 mA	0.4	V
VOL	Low-level dc output voltage	I _{OL} = 20 μA	0.1	,
lı .	Input current (leakage)	V _I = 0 V to 5.5 V	±1	μΑ
10	Output current (leakage)	V _O = 0 V to V _C C	±1	μΑ
IPP1	Vpp supply current	Vpp = V _{CC} = 5.5 V	10	μΑ
IPP2	Vpp supply current (during program pulse)	Vpp = 13 V	50	mA
· F F &.		V _{CC} = 5.5 V, E = V _{IH}	1	mA
ICC1	VCC supply current (standby)	V _{CC} = 5.5 V, \overline{E} = V _{CC}	100	μА
ICC2	VCC supply current (active)	V _{CC} = 5.5 V, E = V _{IL} , t _{cycle} = minimum cycle tlme, outputs open	50	mA

capacitance over recommended ranges of supply voltage and operating free-air temperature, $f\,=\,1\,$ MHz †

	PARAMETER	TEST CONDITIONS	MIN	TYP‡	MAX	UNIT
Ci	Input capacitance	V _I = 0 V		4	8	рF
Co	Output capacitance	V _O = 0 V		8	12	рF

[†] Capacitance measurements are made on a sample basis only.

[‡] Typical values are at T_A = 25°C and nominal voltages.

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switching characteristics over recommended ranges of operating conditions (see Notes 3 and 4)

	PARAMETER	TEST CONDITIONS	'27C240-10 '27PC240-10		'27C240-10		'27C240-15 '27PC240-15		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	1
^t a(A)	Access time from address			100		120		150	ns
ta(E)	Access time from chip enable	C _i = 100 pF,		100		120		150	ns
^t en(G)	Output enable time from G	1 Series 74		50		50		50	ns
^t dis	Output disable time from \overline{G} or $\overline{E},$ whichever occurs first †	TTL load, Input t _r ≤ 20 ns,	0	50	0	50	0	50	ns
t _V (A)	Output data valid time after change of address, E, or G, whichever occurs first	Input t _f ≤ 20 ns	0		0		0		ns

T Value calculated from 0.5 V delta to measured level. This parameter is only sampled and not 100% tested.

switching characteristics for programming: V_{CC} = 6.5 V and V_{PP} = 13 V (SNAP! Pulse), T_A = 25°C (see Note 3)

	PARAMETER	MIN	MAX	UNIT
^t dis(G)	Output disable time from G	0	100	ns
ten(G)	Output enable time from G		150	ns

recommended timing requirements for programming: V_{CC} = 6.5 V and V_{PP} = 13 V (SNAP! Pulse), T_A = 25°C, (see Note 3)

			MIN	TYP	MAX	UNIT
tw(PGM)	Pulse duration, program	SNAP! Pulse programming algorithm	95	100	105	μs
t _{su(A)}	Setup time, address		2			μs
^t su(E)	Setup time, E		2			μs
t _{su(G)}	Setup time, G		2			μs
t _{su(D)}	Setup time, data		2			μS
t _{su(VPP)}	Setup time, Vpp		2			μs
^t su(VCC)	Setup time, VCC		2			μs
^t h(A)	Hold time, address			_		μs
h(D)	Hold time, data					μs

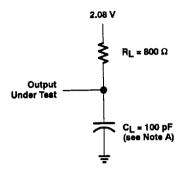
NOTE 3: For all switching characteristics the input pulse levels are 0.4 V to 2.4 V. Timing measurements are made at 2 V for logic high and 0.8 V for logic low. (reference AC Testing Wave Form)

NOTES: 3. For all switching characteristics the input pulse levels are 0.4 V to 2.4 V. Timing measurements are made at 2 V for logic high and 0.8 V for logic low. (reference AC Testing Wave Form)

Common test conditions apply for t_{dis} except during programming.

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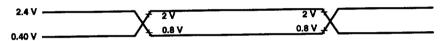
PARAMETER MEASUREMENT INFORMATION



NOTE A: CL includes probe and fixture capacitance.

Figure 2. AC Testing Output Load Circuit

AC testing input/output wave forms



A.C. testing inputs are driven at 2.4 V for logic high and 0.4 V for logic low. Timing measurements are made at 2 V for logic high and 0.8 V for logic low for both inputs and outputs.

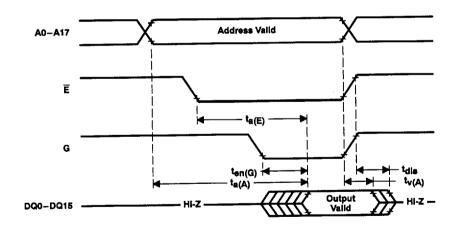
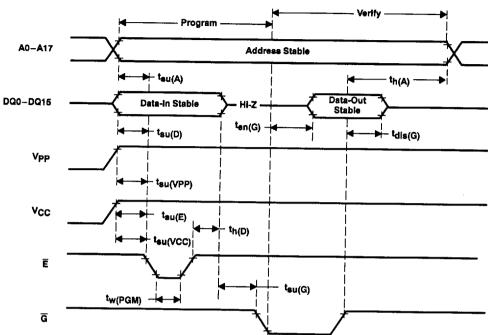


Figure 3. Read-Cycle Timing

TMS27C240 4194304-BIT UV ERASABLE PROGRAMMABLE TMS27PC240 4194304-BIT PROGRAMMABLE READ-ONLY MEMORY SMLS240C - NOVEMBER 1990 - REVISED JUNE 1995

PARAMETER MEASUREMENT INFORMATION



 † 13-V Vpp and 6.5-V VCC for SNAP! Pulse programming

Figure 4. Programming-Cycle Timing (SNAP! Pulse Programming)